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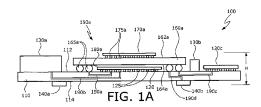
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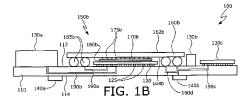
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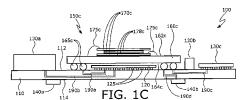
[Continued on next page]

# (54) Title: MAINBOARD ASSEMBLY INCLUDING A PACKAGE OVERLYING A DIE DIRECTLY ATTACHED TO THE MAINBOARD



(57) Abstract: Disclosed are embodiments of a system-level assembly including an integrated circuit (IC) die directly attached to a mainboard. An IC die directly attached to a mainboard or other circuit board may be referred to as a direct-chip attach (DCA) die. A package is disposed over at least a portion of the DCA die and coupled with the mainboard. The package includes one or more other IC die disposed on a substrate. Other embodiments are described and claimed.









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#### A. CLASSIFICATION OF SUBJECT MATTER

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According to International Patent Classification (IPC) or to both national classification and IPC

#### B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

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Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched Korean utility models and applications for utility models

Japanese utility models and applications for utility models

(Chinese Patents and application for patent)

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used) eKOMPASS(KIPO internal) & Keywords: DCA, package, main board

#### C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	US 2006-0197209 A1 (CHOI, BONGSUK et al.) 07 September 2006 See paragraphs 23-30, figure 1, and claims 1, 6, 16.	1-17
A	US 2007-0187826 A1 (SHIM, IL KWON et al.) 16 August 2007 See paragraphs 24-28, figure 1, and claims 1, 16.	1-17
A	US 2008-0042274 A1 (BANG, KYONG-MO et al.) 21 February 2008 See paragraphs 34-35, figure 4, and claims 1, 9, 12.	1-17
A	US 2006-0208348 A1 (TOHRU OHSAKA et al.) 21 September 2006 See paragraphs 80-82, figure 1, and claim 1.	1-17

	Further	documents are	listed	in the	e continuation	of Box	C.
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See patent family annex.

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Information on patent family members

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